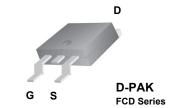
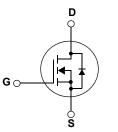
### 询<u>"ECD9N60NTM</u>"供应商 FAIRCHILD May 2010 SupreMOS™ SEMICONDUCTOR® FCD9N60NTM **N-Channel MOSFET 600V, 9A, 0.385**Ω Description Features • $R_{DS(on)} = 0.330\Omega$ (Typ.)@ $V_{GS} = 10V$ , $I_D = 4.5A$ The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling • Ultra low gate charge (Typ. Qg = 22nC) process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise · Low effective output capacitance process control, SupreMOS provides world class Rsp, superior · 100% avalanche tested switching performance and ruggedness. This SupreMOS MOSFET fits the industry's AC-DC SMPS · RoHS compliant requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.





## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

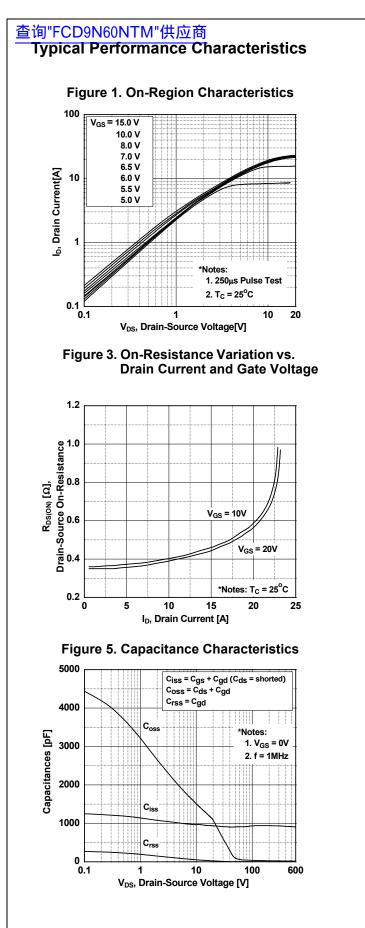
Symbol	Parameter			FCD9N60N	Units
V <sub>DSS</sub>	Drain to Source Voltage			600	V
V <sub>GSS</sub>	Gate to Source Voltage			±30	V
I <sub>D</sub>	Drain Current	-Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		9.0	Α
		-Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		5.7	
I <sub>DM</sub>	Drain Current	- Pulsed (I	Note 1)	27	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		Note 2)	135	mJ
I <sub>AR</sub>	Avalanche Current			3	Α
E <sub>AR</sub>	Repetitive Avalanche Energy			0.83	mJ
dv/dt	MOSFET dv/dt Ruggedness			100	V/ns
	Peak Diode Recovery dv/dt	(	Note 3)	20	V/ns
P <sub>D</sub>	Power Dissipation	$(T_{\rm C} = 25^{\rm o}{\rm C})$		83.3	W
		- Derate above 25°C		0.67	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

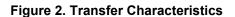
# Thermal Characteristics

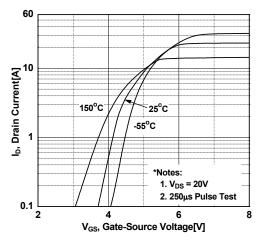
Symbol	Parameter	FCD9N60N	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.5	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	83	°C/vv

FCD9N60NTM 600V N-Channel MOSFET

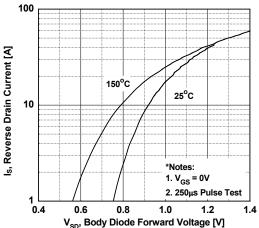
FCD9N6	· · · · · · · · · · · · · · · · · · ·		Package	Reel Size	Тар	e Width		Quantit	y
			DPAK	380mm	1	6mm		2500	
Electrical	l Char	acteristics T <sub>c</sub> =	25 <sup>o</sup> C unless of	therwise noted			I		
Symbol		Parameter		Test Condition	ons	Min.	Тур.	Max.	Units
Off Charact	teristic	5							
3V <sub>DSS</sub>	Drain to	rain to Source Breakdown Voltage		I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V, T <sub>C</sub> = 25 <sup>o</sup> C		600	-	-	V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient		Iro	$I_D = 1$ mA, Referenced to 25°C		-	0.72	-	V/°C
	Zere Cete Maltere Drein Current		, nt	V <sub>DS</sub> = 480V, V <sub>GS</sub> = 0V		-	-	10	
DSS	Zeiu Ga	Zero Gate Voltage Drain Current		$V_{DS}$ = 480V, $V_{GS}$ = 0V, $T_{C}$ = 125°C		-	-	100	μA
GSS	Gate to Body Leakage Current		t Y	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V		-	-	±100	nA
On Charact	teristic	5							
V <sub>GS(th)</sub>	Gate Th	nreshold Voltage		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		2.0	-	4.0	V
R <sub>DS(on)</sub>		rain to Source On Res		$V_{GS} = 10V, I_D = 4.5A$			0.330	0.385	Ω
JFS	Forward Transconductance			$V_{\rm DS} = 40V, I_{\rm D} = 4.5A$		-	7.5	-	S
Dynamic C							000	40.40	
C <sub>iss</sub>		apacitance	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V		-	930	1240	pF	
C <sub>oss</sub>		Capacitance		f = 1MHz		-	35	50	pF
C <sub>rss</sub>		erse Transfer Capacitance				-	2	4	pF
C <sub>oss</sub>		ut Capacitance		$V_{DS}$ = 380V, $V_{GS}$ = 0V, f = 1MHz		-	20	-	pF
C <sub>oss</sub> eff.		ective Output Capacitance		$V_{DS}$ = 0V to 480V, $V_{GS}$ = 0V		-	106	-	pF
Q <sub>g(tot)</sub>		Gate Charge at 10V to Source Gate Charge to Drain "Miller" Charge		$V_{DS} = 380V, I_D = 4.5A,$ $V_{GS} = 10V$ (Note 4) Drain Open		-	22.0	29.0	nC
ସୁ <sub>gs</sub>	Gate to					-	4.1	-	nC
Q <sub>gd</sub>	Gate to					-	7.1	-	nC
ESR	Equivalent Series Resistance (G-S)		(G-S)				2.9		Ω
Switching (	Charac	teristics							
d(on)	Turn-On Delay Time					-	12.7	35.4	ns
r		Rise Time	,	V <sub>DD</sub> = 380V, I <sub>D</sub> = 4.5A	-	-	8.7	27.4	ns
		f Delay Time		$R_{G} = 4.7\Omega$ (Note 4)		-	36.9	83.8	ns
ld/off)		f Fall Time				-	10.2	30.4	ns
					(				
t <sub>d(off)</sub> t <sub>f</sub> Drain-Sour		lo Charactoristic	-						
rain-Sour	1	<b>de Characteristic</b> m Continuous Drain to		Forward Current		-	-	9.0	Α
h Drain-Sour	Maximu		Source Diode			-	-	9.0 27	A A
f <b>Drain-Sour</b> s sм	Maximu Maximu	m Continuous Drain to	Source Diode rce Diode Forw	vard Current			-		
ք Drain-Sour Տ	Maximu Maximu Drain to	m Continuous Drain to m Pulsed Drain to Sou	Source Diode rce Diode Forw Voltage			-	- - - 213	27	Α



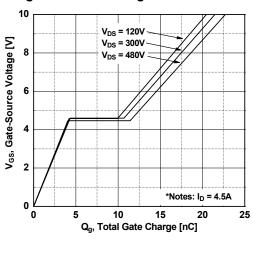


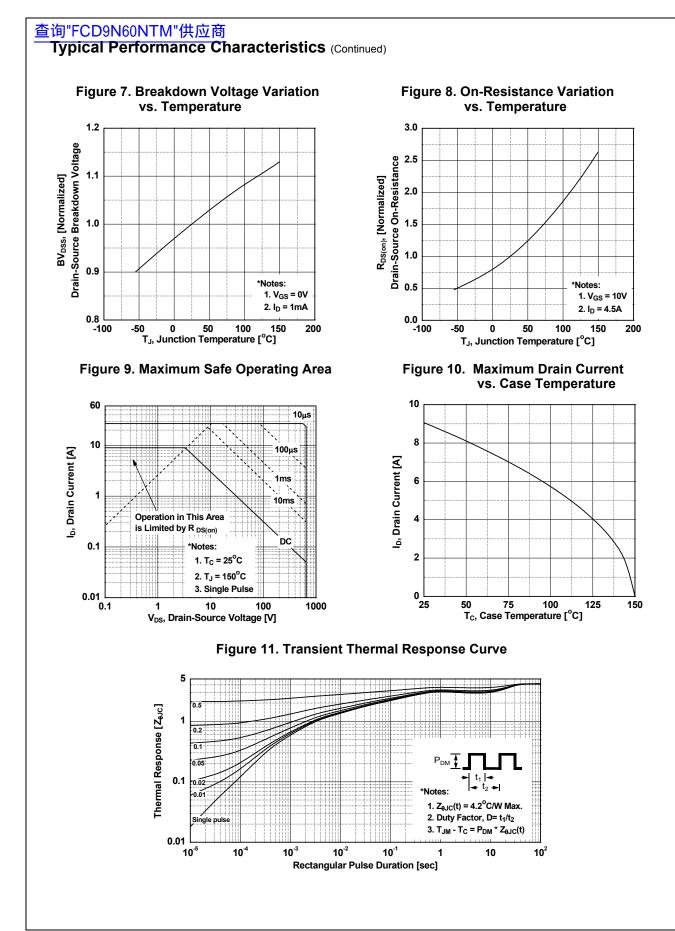


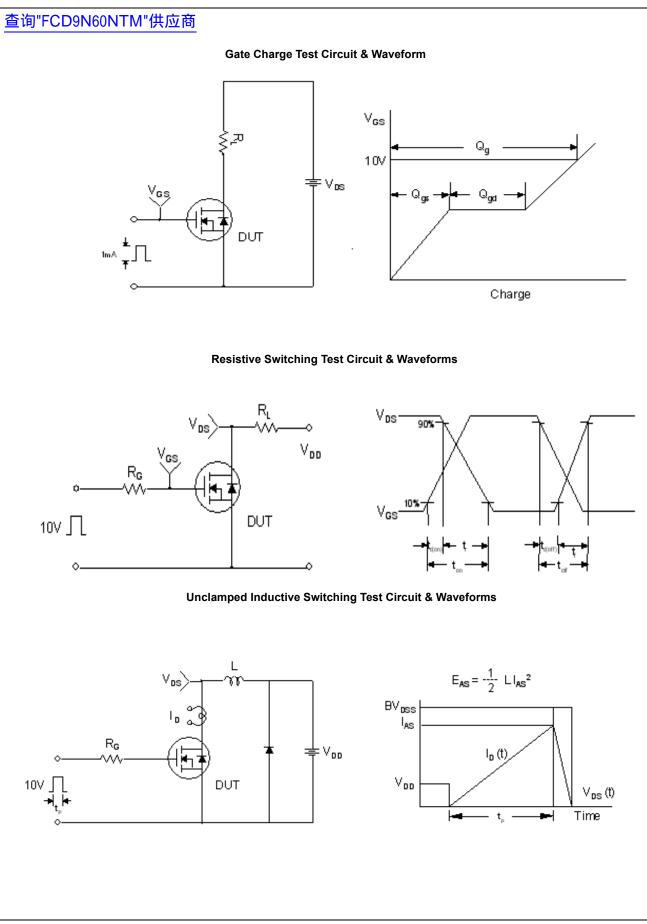








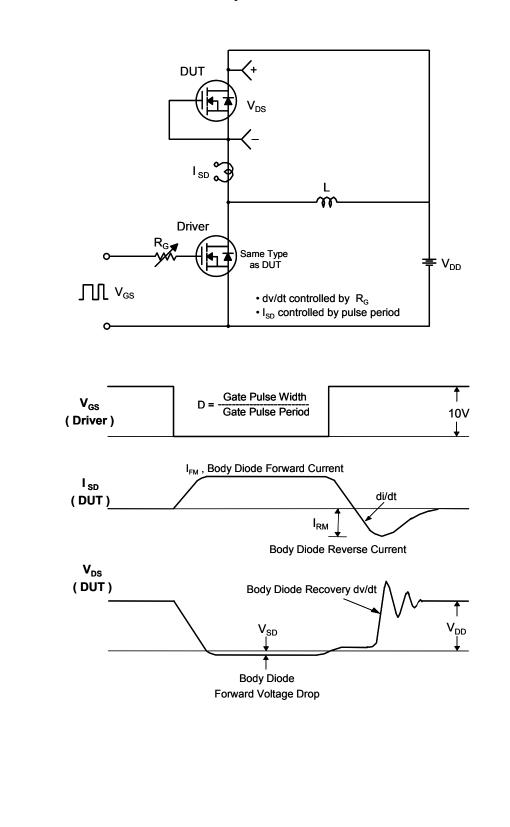


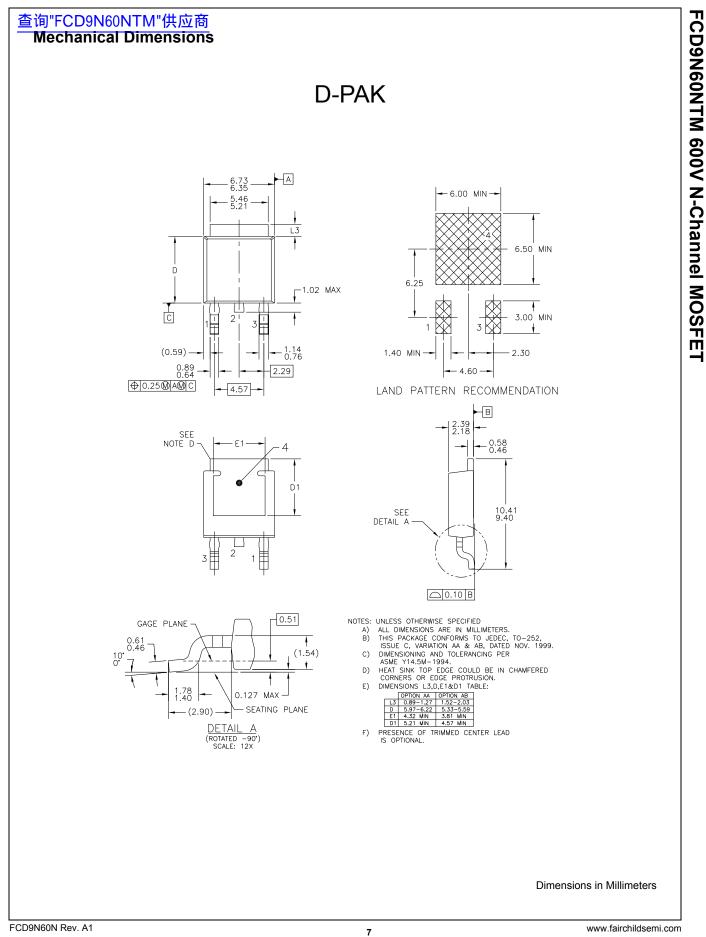


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查询"FCD9N60NTM"供应商

## Peak Diode Recovery dv/dt Test Circuit & Waveforms





# 查询"FCD9N60NTM"供应商

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